



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

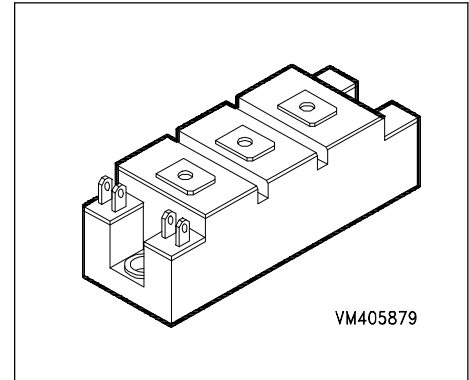
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## IGBT Power Module

- Half-bridge
- Including fast free-wheeling diodes
- Package with insulated metal base plate
- $R_{G\ on, \min} = 27\ \Omega$



Type	$V_{CE}$	$I_C$	Package	Ordering Code
BSM 50 GB 170 DN2	1700V	72A	HALF-BRIDGE 1	C67070-A2701-A67

## Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	$V_{CE}$	1700	V
Collector-gate voltage	$V_{CGR}$	1700	
$R_{GE} = 20\ k\Omega$			
Gate-emitter voltage	$V_{GE}$	$\pm 20$	
DC collector current	$I_C$		A
$T_C = 25\ ^\circ C$		72	
$T_C = 80\ ^\circ C$		50	
Pulsed collector current, $t_p = 1\ ms$	$I_{Cpuls}$		
$T_C = 25\ ^\circ C$		144	
$T_C = 80\ ^\circ C$		100	
Power dissipation per IGBT	$P_{tot}$		W
$T_C = 25\ ^\circ C$		500	
Chip temperature	$T_j$	+ 150	$^\circ C$
Storage temperature	$T_{stg}$	-40 ... + 125	
Thermal resistance, chip case	$R_{thJC}$	$\leq 0.25$	K/W
Diode thermal resistance, chip case	$R_{thJCD}$	$\leq 0.75$	
Insulation test voltage, $t = 1\ min.$	$V_{is}$	4000	Vac
Creepage distance	-	20	mm
Clearance	-	11	
DIN humidity category, DIN 40 040	-	F	sec
IEC climatic category, DIN IEC 68-1	-	40 / 125 / 56	

**Electrical Characteristics**, at  $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Gate threshold voltage $V_{GE} = V_{CE}, I_C = 4\text{ mA}$	$V_{GE(th)}$	4.8	5.5	6.2	V
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}, I_C = 50\text{ A}, T_j = 25\text{ °C}$ $V_{GE} = 15\text{ V}, I_C = 50\text{ A}, T_j = 125\text{ °C}$	$V_{CE(sat)}$	- -	3.4 4.6	3.9 5.3	
Zero gate voltage collector current $V_{CE} = 1700\text{ V}, V_{GE} = 0\text{ V}, T_j = 25\text{ °C}$ $V_{CE} = 1700\text{ V}, V_{GE} = 0\text{ V}, T_j = 125\text{ °C}$	$I_{CES}$	- -	0.4 1.6	0.5 -	mA
Gate-emitter leakage current $V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$	$I_{GES}$	-	-	320	nA

**AC Characteristics**

Transconductance $V_{CE} = 20\text{ V}, I_C = 50\text{ A}$	$g_{fs}$	18	-	-	S
Input capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	-	8	-	nF
Output capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{oss}$	-	0.64	-	
Reverse transfer capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{rss}$	-	0.25	-	

**Electrical Characteristics**, at  $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Switching Characteristics, Inductive Load at  $T_j = 125\text{ °C}$** 

Turn-on delay time $V_{CC} = 1200\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 50\text{ A}$ $R_{Gon} = 27\ \Omega$	$t_{d(on)}$	-	350	700	ns
Rise time $V_{CC} = 1200\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 50\text{ A}$ $R_{Gon} = 27\ \Omega$	$t_r$	-	150	300	
Turn-off delay time $V_{CC} = 1200\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 50\text{ A}$ $R_{Goff} = 27\ \Omega$	$t_{d(off)}$	-	650	1000	
Fall time $V_{CC} = 1200\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 50\text{ A}$ $R_{Goff} = 27\ \Omega$	$t_f$	-	90	140	

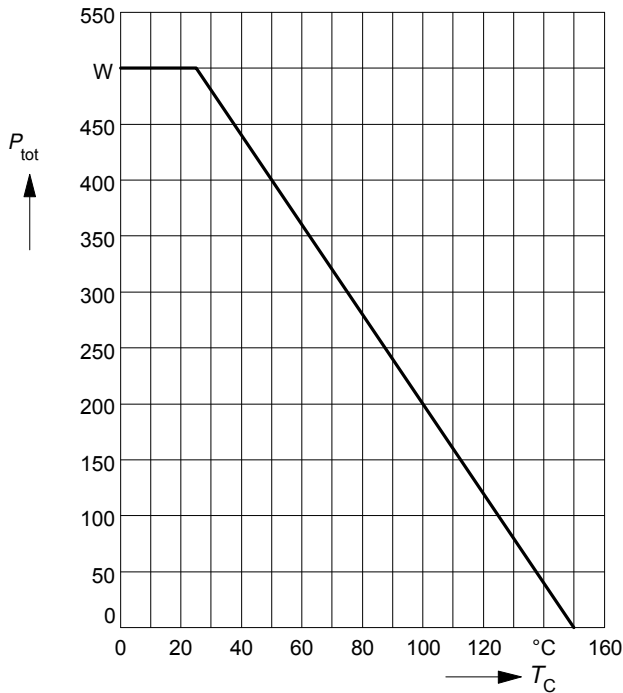
**Free-Wheel Diode**

Diode forward voltage $I_F = 50\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 25\text{ °C}$ $I_F = 50\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 125\text{ °C}$	$V_F$	-	2.3 2.1	2.8 -	V
Reverse recovery time $I_F = 50\text{ A}$ , $V_R = -1200\text{ V}$ , $V_{GE} = 0\text{ V}$ $di_F/dt = -600\text{ A}/\mu\text{s}$ , $T_j = 125\text{ °C}$	$t_{rr}$	-	0.3	-	$\mu\text{s}$
Reverse recovery charge $I_F = 50\text{ A}$ , $V_R = -1200\text{ V}$ , $V_{GE} = 0\text{ V}$ $di_F/dt = -600\text{ A}/\mu\text{s}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	$Q_{rr}$	-	4 12	- -	$\mu\text{C}$

Power dissipation

$P_{tot} = f(T_C)$

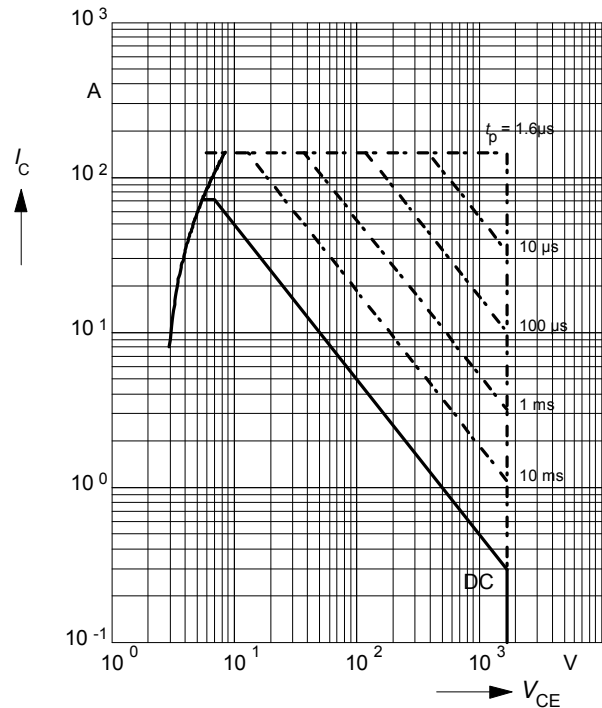
parameter:  $T_j \leq 150\text{ }^\circ\text{C}$



Safe operating area

$I_C = f(V_{CE})$

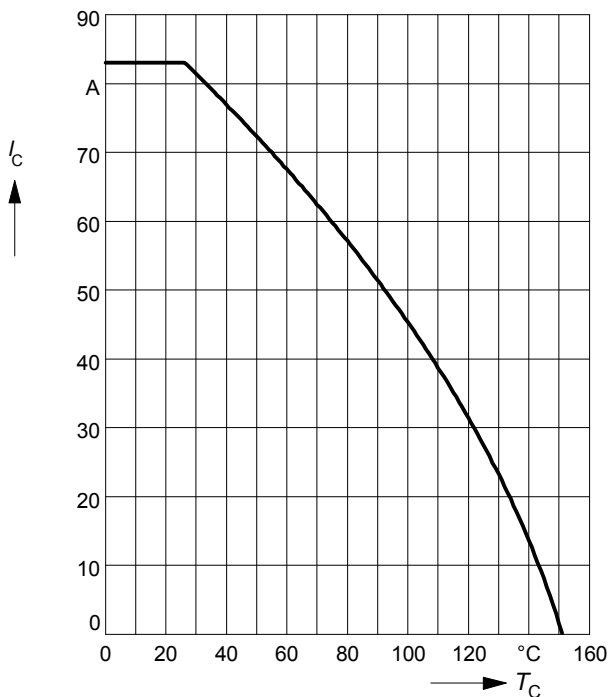
parameter:  $D = 0, T_C = 25\text{ }^\circ\text{C}, T_j \leq 150\text{ }^\circ\text{C}$



Collector current

$I_C = f(T_C)$

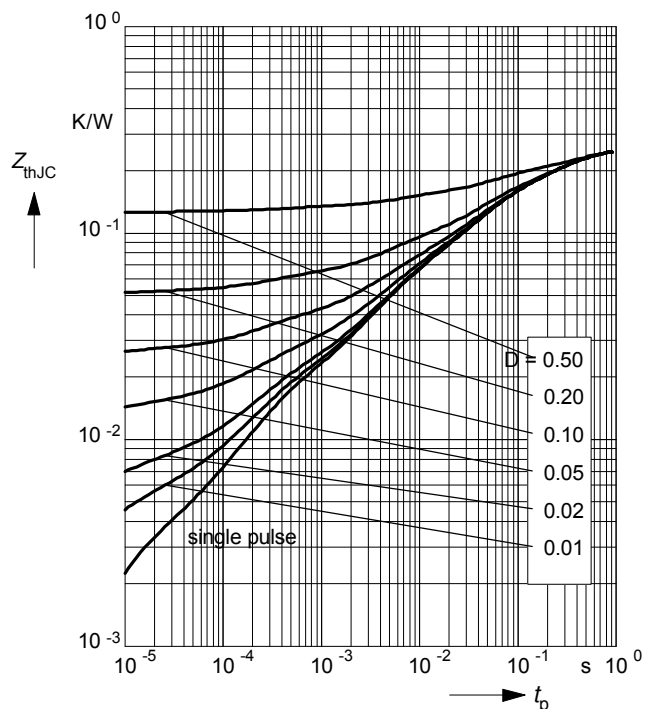
parameter:  $V_{GE} \geq 15\text{ V}, T_j \leq 150\text{ }^\circ\text{C}$



Transient thermal impedance IGBT

$Z_{thJC} = f(t_p)$

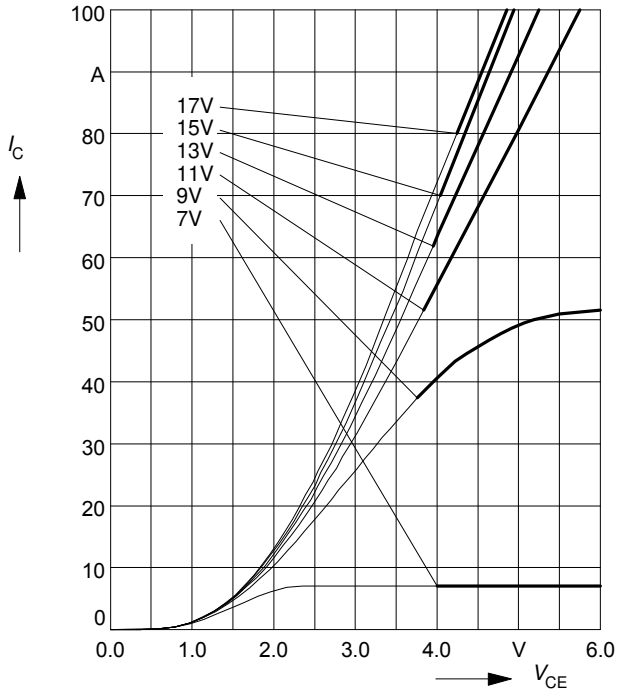
parameter:  $D = t_p / T$



**Typ. output characteristics**

$I_C = f(V_{CE})$

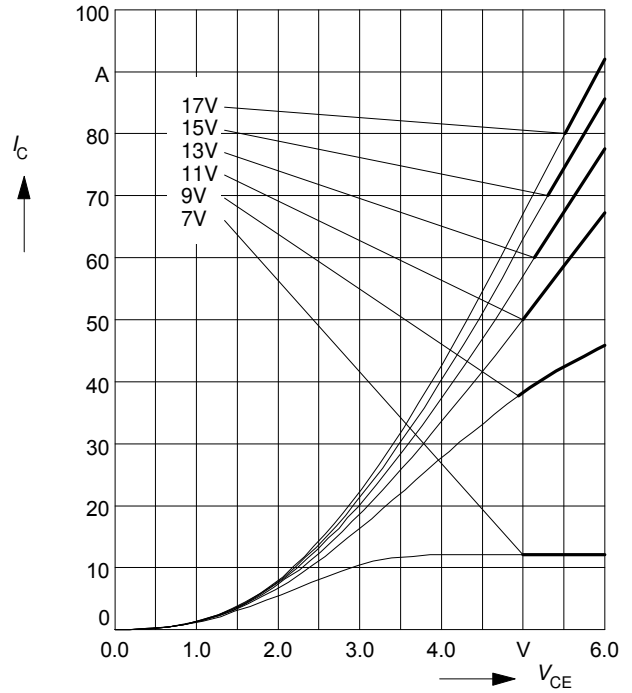
parameter:  $t_p = 80 \mu s, T_j = 25 \text{ }^\circ\text{C}$



**Typ. output characteristics**

$I_C = f(V_{CE})$

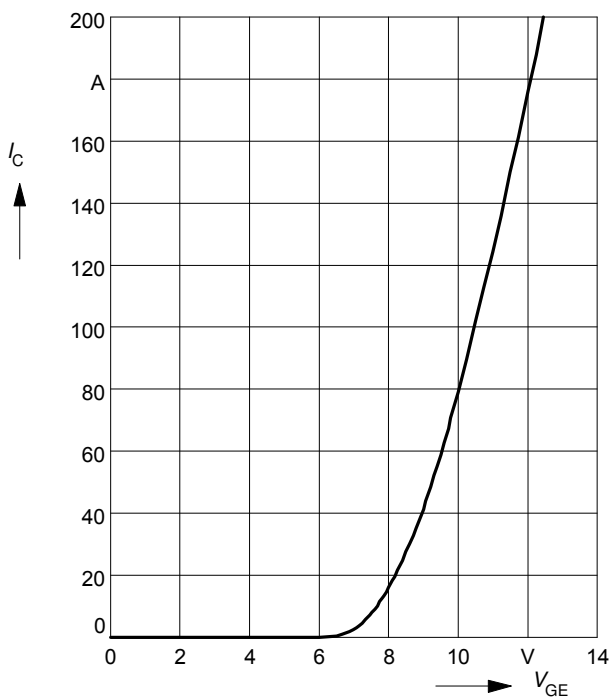
parameter:  $t_p = 80 \mu s, T_j = 125 \text{ }^\circ\text{C}$



**Typ. transfer characteristics**

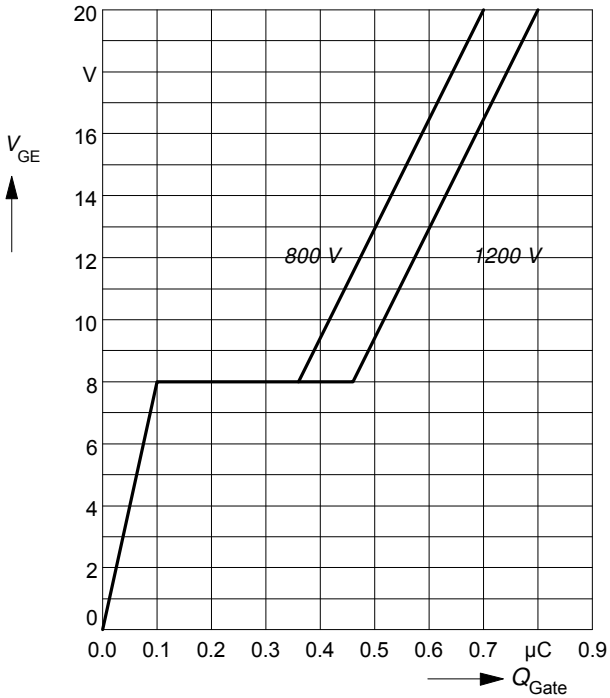
$I_C = f(V_{GE})$

parameter:  $t_p = 80 \mu s, V_{CE} = 20 \text{ V}$



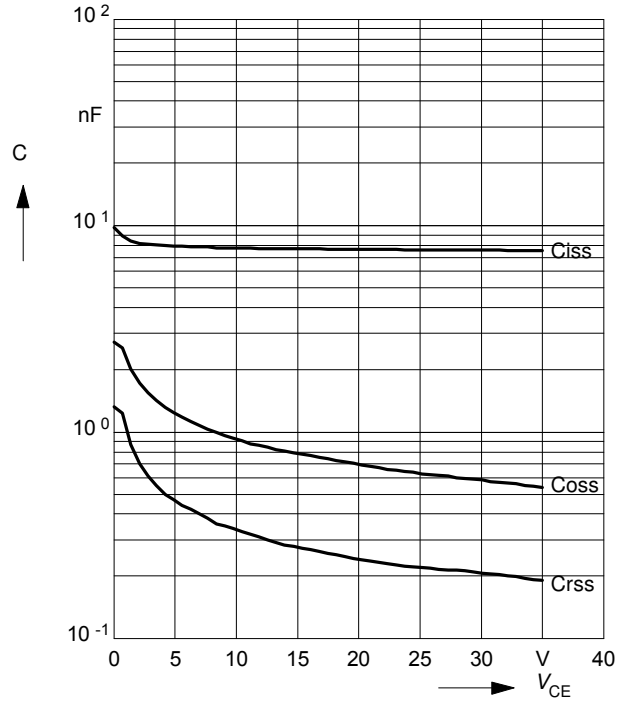
**Typ. gate charge**

$V_{GE} = f(Q_{Gate})$   
 parameter:  $I_{C\ puls} = 50\text{ A}$



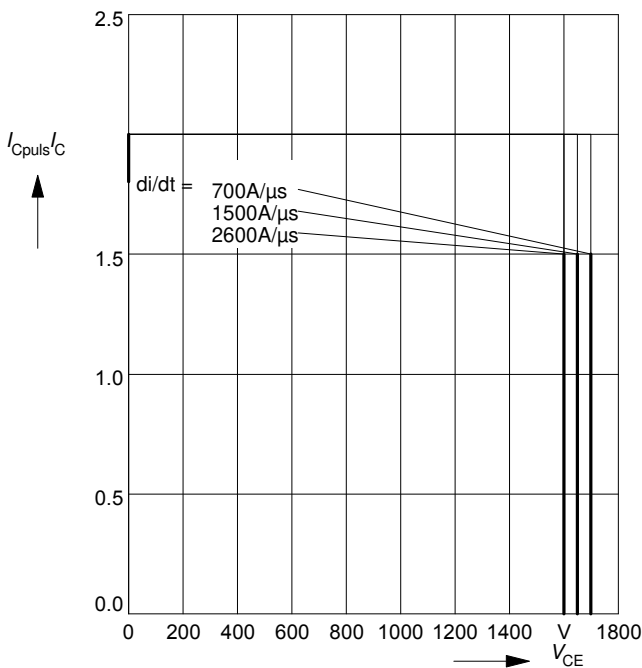
**Typ. capacitances**

$C = f(V_{CE})$   
 parameter:  $V_{GE} = 0, f = 1\text{ MHz}$



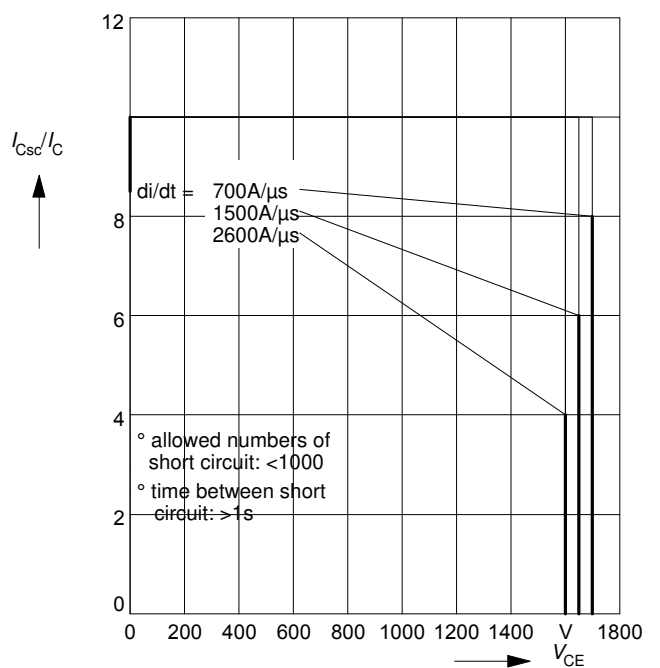
**Reverse biased safe operating area**

$I_{C\ puls} = f(V_{CE}), T_j = 150^\circ\text{C}$   
 parameter:  $V_{GE} = \pm 15\text{ V}, t_p \leq 1\text{ ms}, L < 50\text{ nH}$



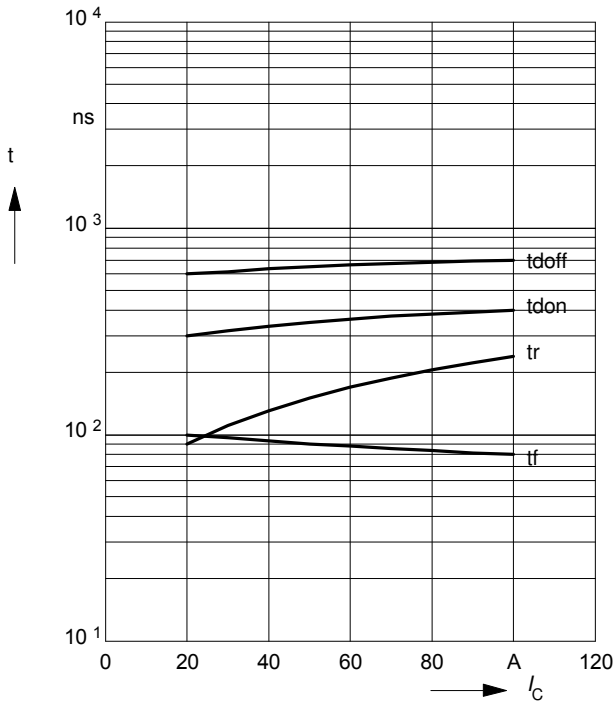
**Short circuit safe operating area**

$I_{C\ sc} = f(V_{CE}), T_j = 150^\circ\text{C}$   
 parameter:  $V_{GE} = \pm 15\text{ V}, t_p \leq 10\ \mu\text{s}, L < 50\text{ nH}$



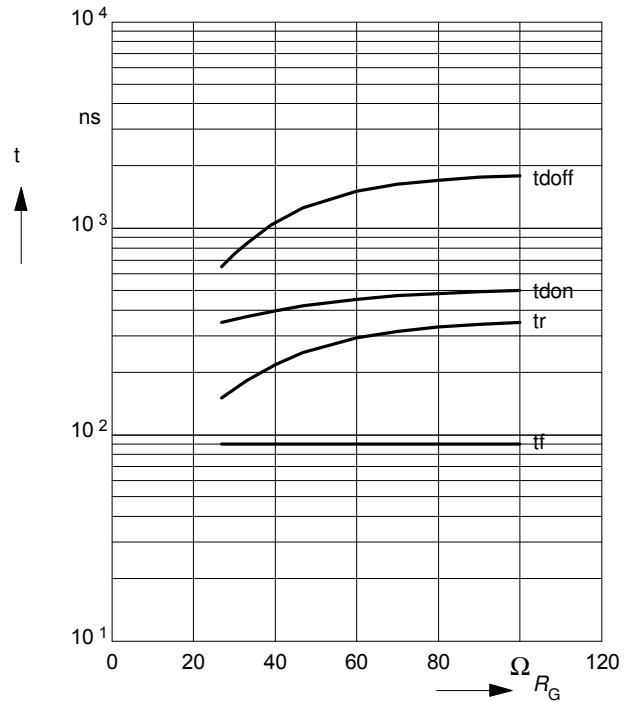
**Typ. switching time**

$t = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 1200\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 27\ \Omega$



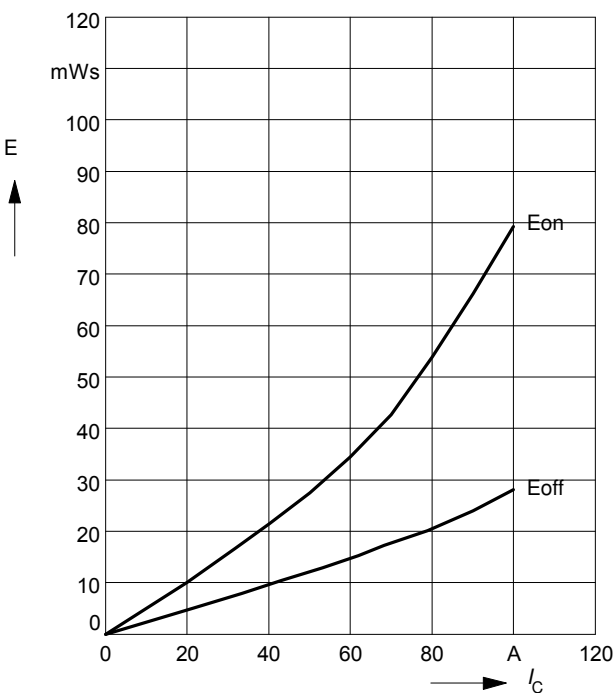
**Typ. switching time**

$t = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 1200\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 50\text{ A}$



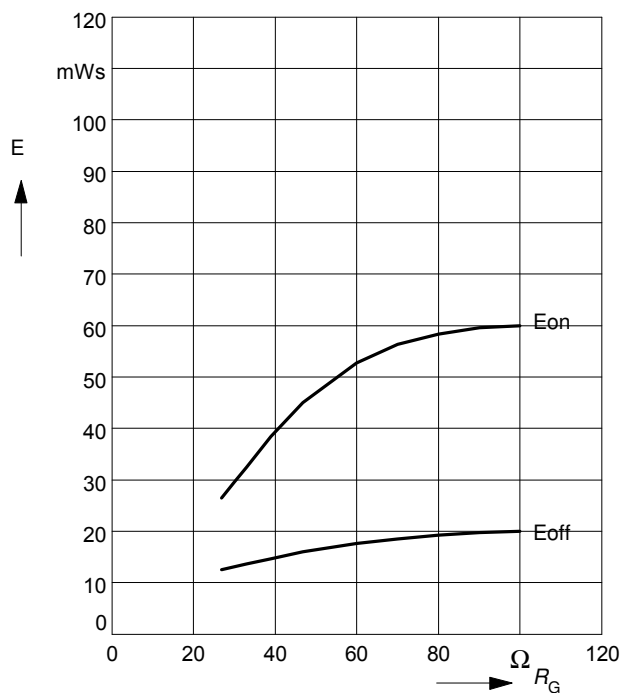
**Typ. switching losses**

$E = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 1200\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 27\ \Omega$



**Typ. switching losses**

$E = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 1200\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 50\text{ A}$

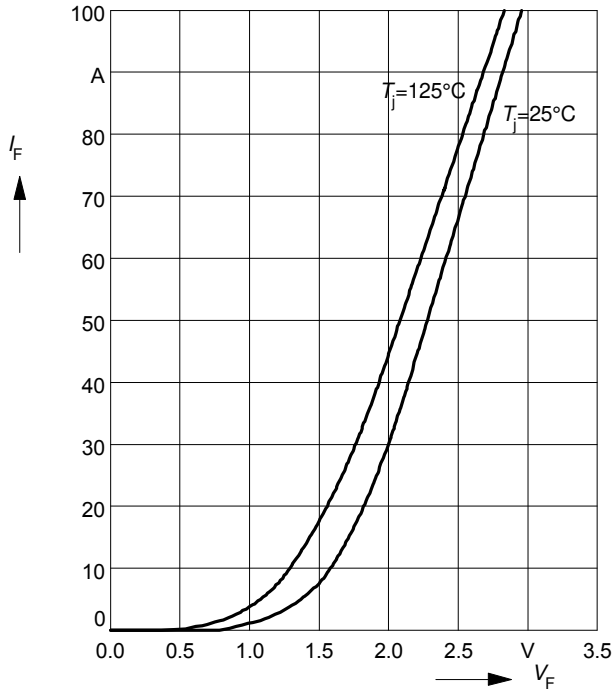




**Forward characteristics of fast recovery**

**reverse diode**  $I_F = f(V_F)$

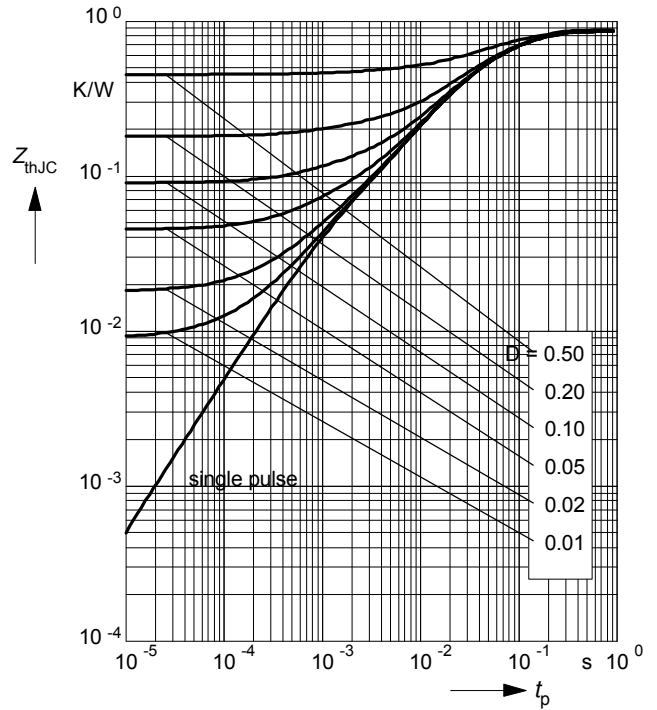
parameter:  $T_j$



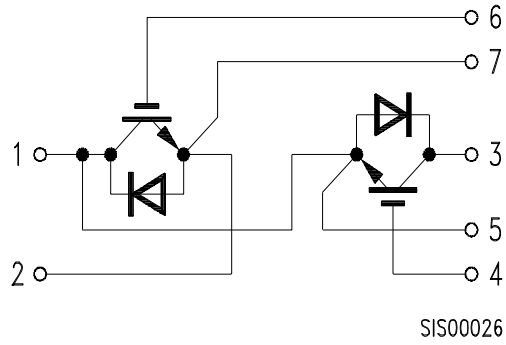
**Transient thermal impedance Diode**

$Z_{thJC} = f(t_p)$

parameter:  $D = t_p / T$



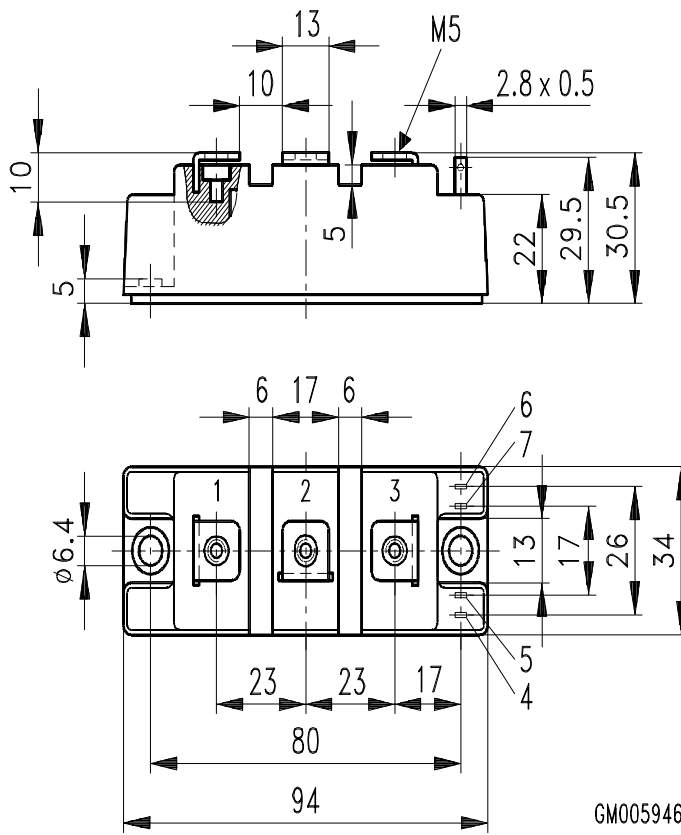
**Circuit Diagram**



**Package Outlines**

Dimensions in mm

Weight: 250 g



## Nutzungsbedingungen

Die in diesem Produktdatenblatt enthaltenen Daten sind ausschließlich für technisch geschultes Fachpersonal bestimmt. Die Beurteilung der Geeignetheit dieses Produktes für die von Ihnen anvisierte Anwendung sowie die Beurteilung der Vollständigkeit der bereitgestellten Produktdaten für diese Anwendung obliegt Ihnen bzw. Ihren technischen Abteilungen.

In diesem Produktdatenblatt werden diejenigen Merkmale beschrieben, für die wir eine liefervertragliche Gewährleistung übernehmen. Eine solche Gewährleistung richtet sich ausschließlich nach Maßgabe der im jeweiligen Liefervertrag enthaltenen Bestimmungen. Garantien jeglicher Art werden für das Produkt und dessen Eigenschaften keinesfalls übernommen.

Sollten Sie von uns Produktinformationen benötigen, die über den Inhalt dieses Produktdatenblatts hinausgehen und insbesondere eine spezifische Verwendung und den Einsatz dieses Produktes betreffen, setzen Sie sich bitte mit dem für Sie zuständigen Vertriebsbüro in Verbindung (siehe [www.eupec.com](http://www.eupec.com), Vertrieb&Kontakt). Für Interessenten halten wir Application Notes bereit.

Aufgrund der technischen Anforderungen könnte unser Produkt gesundheitsgefährdende Substanzen enthalten. Bei Rückfragen zu den in diesem Produkt jeweils enthaltenen Substanzen setzen Sie sich bitte ebenfalls mit dem für Sie zuständigen Vertriebsbüro in Verbindung.

Sollten Sie beabsichtigen, das Produkt in Anwendungen der Luftfahrt, in gesundheits- oder lebensgefährdenden oder lebenserhaltenden Anwendungsbereichen einzusetzen, bitten wir um Mitteilung. Wir weisen darauf hin, dass wir für diese Fälle

- die gemeinsame Durchführung eines Risiko- und Qualitätsassessments;
- den Abschluss von speziellen Qualitätssicherungsvereinbarungen;
- die gemeinsame Einführung von Maßnahmen zu einer laufenden Produktbeobachtung dringend empfehlen und gegebenenfalls die Belieferung von der Umsetzung solcher Maßnahmen abhängig machen.

Soweit erforderlich, bitten wir Sie, entsprechende Hinweise an Ihre Kunden zu geben.

Inhaltliche Änderungen dieses Produktdatenblatts bleiben vorbehalten.

## Terms & Conditions of usage

The data contained in this product data sheet is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see [www.eupec.com](http://www.eupec.com), sales&contact). For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

Please note, that for any such applications we urgently recommend

- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

If and to the extent necessary, please forward equivalent notices to your customers.

Changes of this product data sheet are reserved.